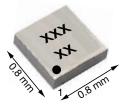
www.vishay.com

Vishay Siliconix

N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A) ^a	Q _g (TYP.)			
20	0.060 at V _{GS} = 4.5 V	3.2				
	0.062 at V_{GS} = 3.7 V	3.1	6.3 nC			
	0.071 at V _{GS} = 2.5 V	3.0	0.5 110			
	0.093 at V _{GS} = 1.8 V	2.7				

MICRO FOOT® 0.8 x 0.8 s





Backside View

Marking Code: xx = AG xxx = Date/Lot traceability code

Ordering Information:

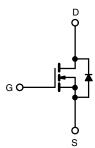
Si8812DB-T2-E1 (lead (Pb)-free and halogen-free)

FEATURES

- TrenchFET[®] power MOSFET
- Small 0.8 mm x 0.8 mm outline area
- Low 0.4 mm max. profile
- Low On-resistance
- FREE Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Load switch with low voltage drop
- Power management
- For smart phones, tablet PCs, mobile computing



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, u	nless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 8	v	
	T _A = 25 °C		3.2 ^a		
Continuous Drain Current (T 150 °C)	T _A = 70 °C		2.6 ^a		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	2.3 ^b		
	T _A = 70 °C		1.8 ^b	A	
Pulsed Drain Current (t = 300 µs)		I _{DM}	20		
	T _A = 25 °C		0.7 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.4 ^b		
	T _A = 25 °C		0.9 ^a		
Mauineuro Davier Dia sin atian	T _A = 70 °C		0.6 ^a	w	
Maximum Power Dissipation	T _A = 25 °C	PD	0.5 ^b	vv	
	T _A = 70 °C		0.3 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg} -55 to +150		*0	
Soldering Recommendations (Peak Temperature) ^c			260		

THERMAL RESISTANCE RATING	RMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient a, d	t < 5 o	Р	105	135	°C/W	
Maximum Junction-to-Ambient ^{b, e}	t≤5s	R _{thJA}	200	260	C/W	

Notes

a. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s.

b. Surface mounted on 1" x 1" FR4 board with minimum copper, t = 5 s.

c. Refer to IPC/JEDEC® (J-STD-020), no manual or hand soldering.

d. Maximum under steady state conditions is 185 °C/W.

e. Maximum under steady state conditions is 330 °C/W.

S16-0758-Rev. C, 02-May-16

1

Document Number: 63682



RoHS COMPLIANT HALOGEN

Vishay Siliconix

Si8812DB

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static		I		1			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	20	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		_	29	-	- mV/°C	
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μΑ	_	-2.6	-		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.4	-	1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$	-	-	± 100	nA	
Zana Oata Malta za Duzin Oriment		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, $V_{GS} = 4.5$ V	10	-	-	А	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	-	0.048	0.060	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 3.7 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	-	0.049	0.062		
	1 (DS(0h)	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	-	0.052	0.071	52	
		V _{GS} = 1.8 V, I _D = 0.5 A	-	0.060	0.093		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}$	-	12	-	S	
Dynamic ^b							
otal Gate Charge	Qa	$V_{DS} = 10 \text{ V}, V_{GS} = 8 \text{ V}, I_D = 1 \text{ A}$	-	11	17	nC	
	-		-	6.3	10		
Gate-Source Charge	Q _{gs}	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 1 \text{ A}$		0.8	-		
Gate-Drain Charge	Q _{gd}		-	1.4	-	<u> </u>	
Gate Resistance	Rg	f = 1 MHz	-	6	-	Ω	
Turn-On Delay Time	t _{d(on)}		-	10	20		
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω	-	13	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, \text{R}_\text{g} = 1 \Omega$	-	33	60		
Fall Time	t _f		-	10	20		
Turn-On Delay Time	t _{d(on)}		-	5	10	ns	
Rise Time	t _r	$\begin{array}{c c} Q_{g} \\ \hline Q_{gs} \\ \hline Q_{gd} \\ \hline R_{g} \\ \hline f = 1 \text{ MHz} \\ \hline \\ $	_	11	20		
Turn-Off Delay Time	t _{d(off)}		-	25	50		
Fall Time	t _f		-	10	20	1	
Drain-Source Body Diode Characteristic	s	•	•	•	•		
Continuous Source-Drain Diode Current	ا _S	T _A = 25 °C	-	-	0.7		
Pulse Diode Forward Current	I _{SM}		-	-	20	A	
Body Diode Voltage	V _{SD}	I _S = 1 A, V _{GS} = 0 V	_	0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	10	20	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1	-	3	10	nC	
Reverse Recovery Fall Time	ta	I _F = 1 A, di/dt = 100 A/μs, T _J = 25 °C	_	6	-	1	
Reverse Recovery Rise Time		4	_	4	_	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

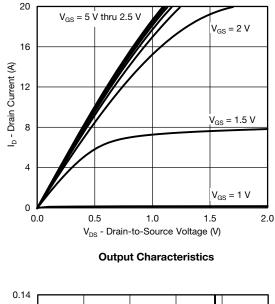
www.vishay.com

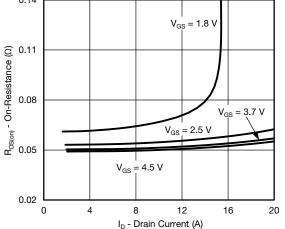
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



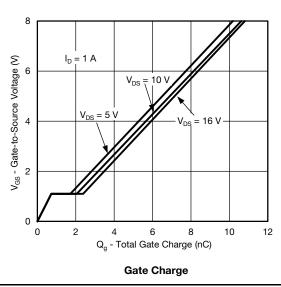
Vishay Siliconix

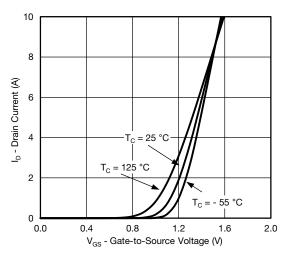
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



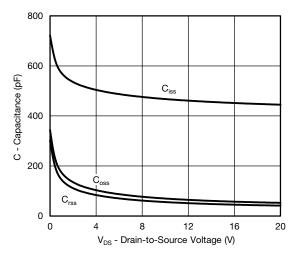


On-Resistance vs. Drain Current

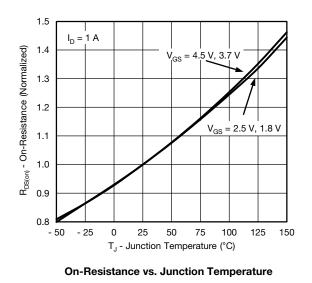




Transfer Characteristics



Capacitance



S16-0758-Rev. C, 02-May-16

3

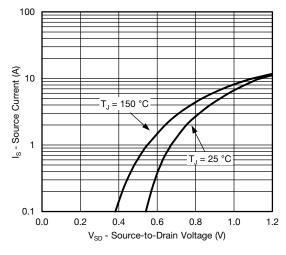
Document Number: 63682

For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

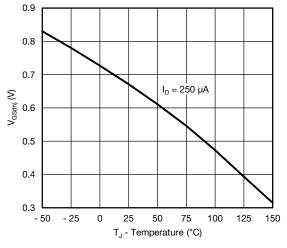


Vishay Siliconix

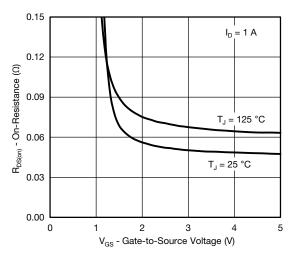
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



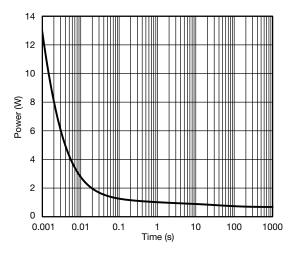
Source-Drain Diode Forward Voltage



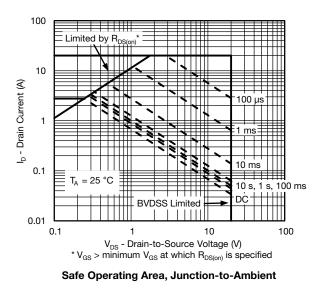




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



Document Number: 63682

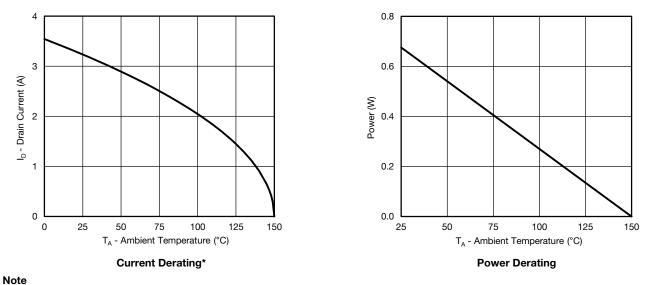
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

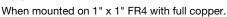
4



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



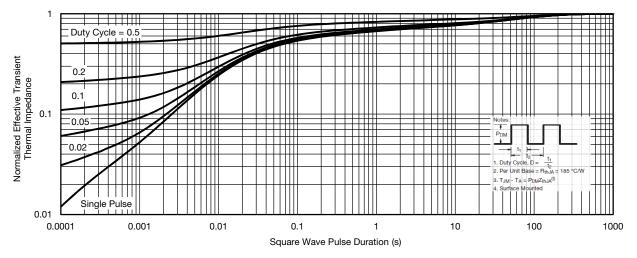


* The power dissipation PD is based on TJ (max.) = 150 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

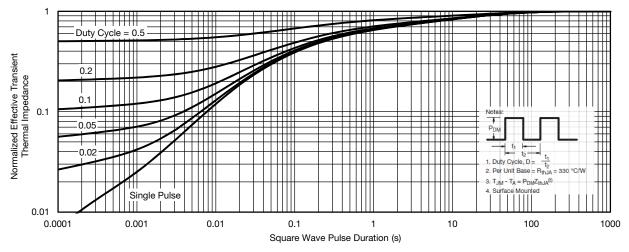


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient (On 1" x 1" FR4 Board with Maximum Copper)



Normalized Thermal Transient Impedance, Junction-to-Ambient (On 1" x 1" FR4 Board with Minimum Copper)

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63682.

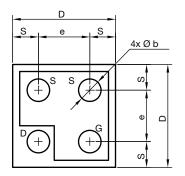


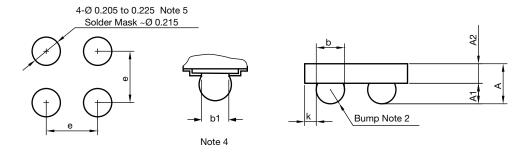
Vishay Siliconix

MICRO FOOT®: 4-Bump (0.8 mm x 0.8 mm, 0.4 mm Pitch)









Notes

⁽¹⁾ Laser mark on the backside surface of die

⁽²⁾ Bumps are 95.5 % Sn,3.8 % Ag,0.7 % Cu

⁽³⁾ "i" is the location of pin 1

⁽⁴⁾ "b1" is the diameter of the solderable substrate surface, defined by an opening in the solder resist layer solder mask defined.

⁽⁵⁾ Non-solder mask defined copper landing pad.

DIM.	MILLIMETERS ^a			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.328	0.365	0.402	0.0129	0.0144	0.0158
A1	0.136	0.160	0.184	0.0053	0.0062	0.0072
A2	0.192	0.205	0.218	0.0076	0.0081	0.0086
b	0.200	0.220	0.240	0.0078	0.0086	0.0094
b1	0.175			0.0068		
е		0.400		0.0157		
S	0.160	0.180	0.200	0.0062	0.0070	0.0078
D	0.720	0.760	0.800	0.0283	0.0299	0.0314
К	0.040	0.070	0.100	0.0015	0.0027	0.0039

Note

a. Use millimeters as the primary measurement.

ECN: T15-0053-Rev. A, 16-Feb-15 DWG: 6033

Revision: 16-Feb-15

1



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SI8812DB-T2-E1